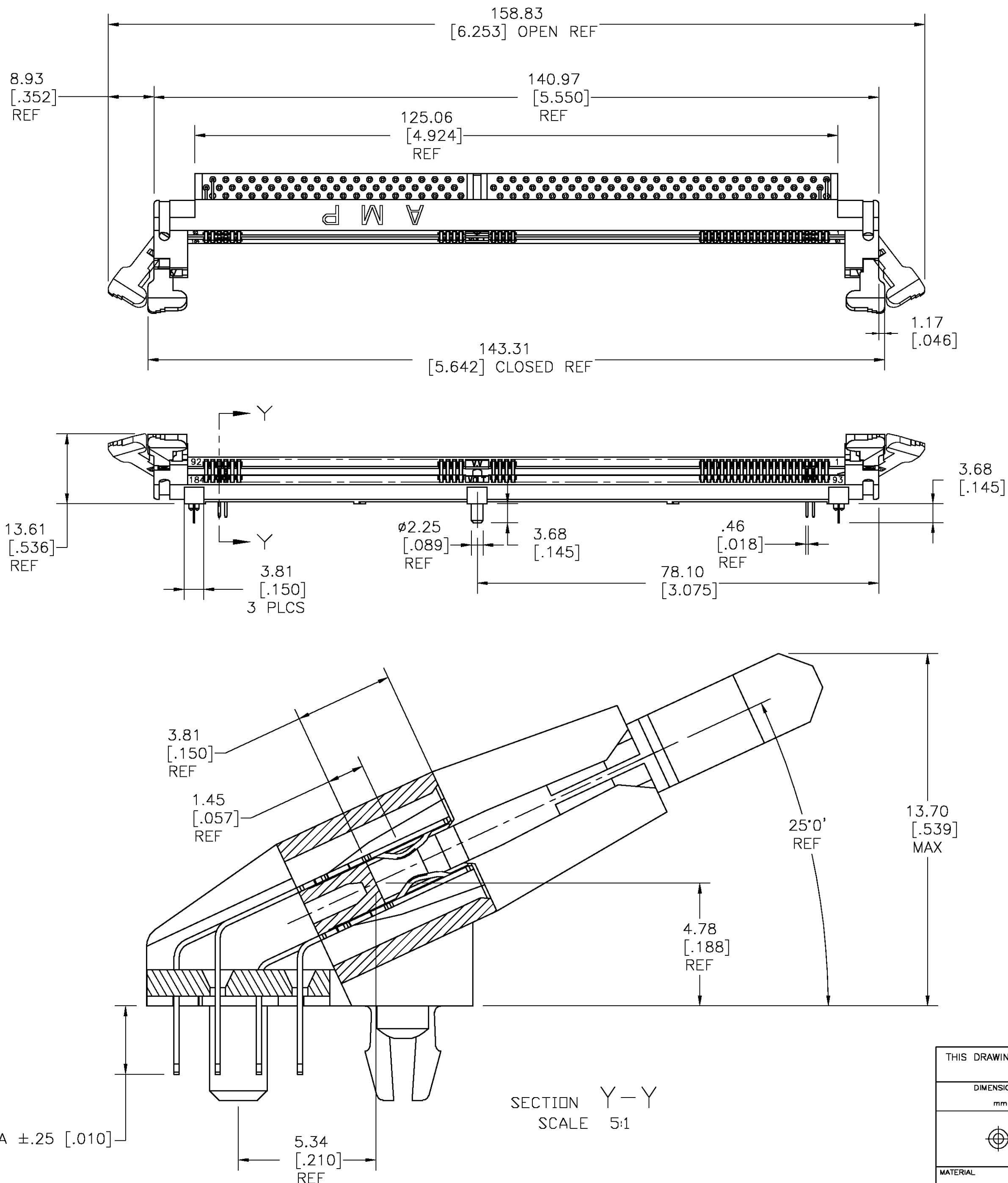


D

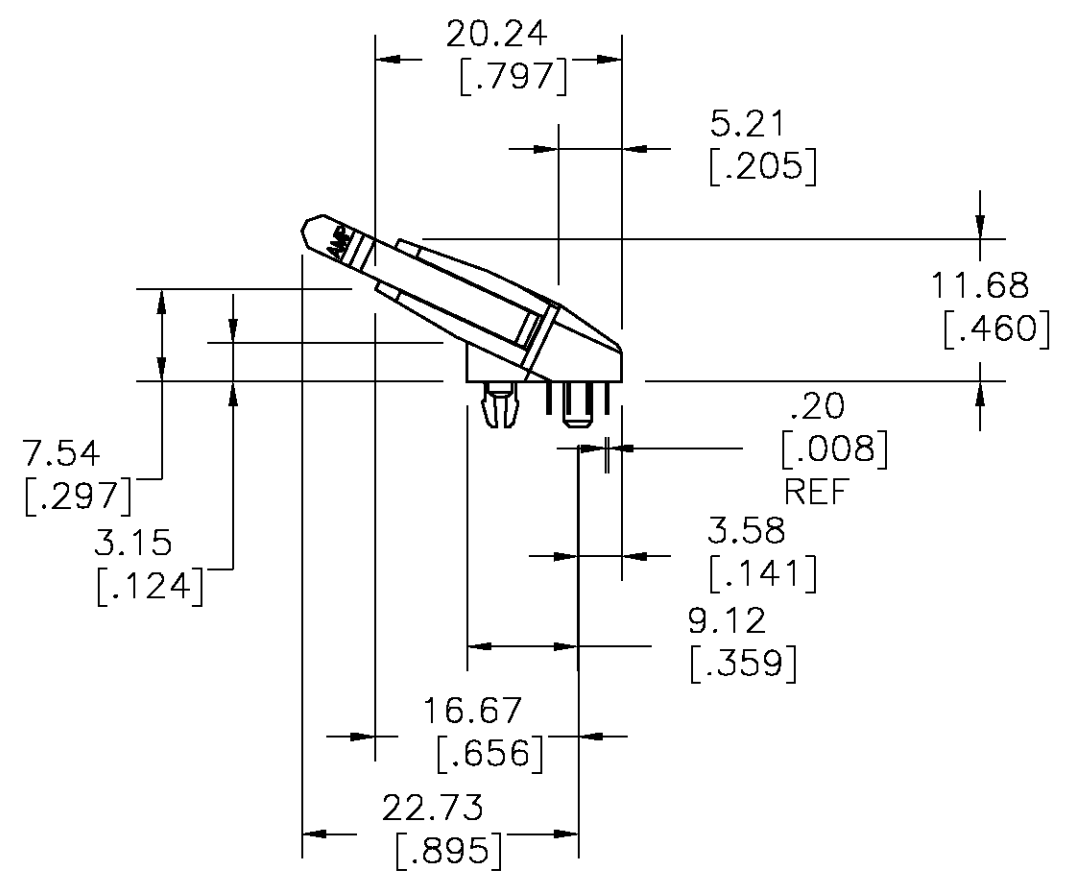
C

B

A



1. MATERIAL:
HOUSING AND EJECTOR: HIGH TEMPERATURE NYLON
CONTACT: PHOS BRONZE
2. FINISH:
CONTACT AREA: 0.00076 [0.00030] GOLD OVER NICKEL
SOLDER TAIL: MATTE TIN OVER NICKEL
3. MODULE BOARD PADS:
FOR OPTIMUM PERFORMANCE PADS SHOULD BE SMOOTH AND FLAT
PADS TO BE PLATED WITH:
0.00102 [0.00040] MIN THICK GOLD OVER
0.00127 [0.00050] MIN THICK NICKEL



6761532

B

A

DIM A ±.25 [.010]

SECTION Y-Y
SCALE 5:1

THIS DRAWING IS A CONTROLLED DOCUMENT.

DIMENSIONS:
mm

TOLERANCES UNLESS OTHERWISE SPECIFIED:

0 PLC	±	-
1 PLC	±	-
2 PLC	±	0.13 [.005]
3 PLC	±	-
4 PLC	±	-
ANGLES	±	-
FINISH	-	-

MATERIAL

-

DWN S.WAITMA 27JUN05
CHK M. YEOMANS 27JUN05
APVD M. YEOMANS 27JUN05
PRODUCT SPEC
APPLICATION SPEC
WEIGHT
CUSTOMER DRAWING

27JUN05
27JUN05
27JUN05

tyco
Electronics

Tyco Electronics Corporation
Middletown, Pa 17057

NAME

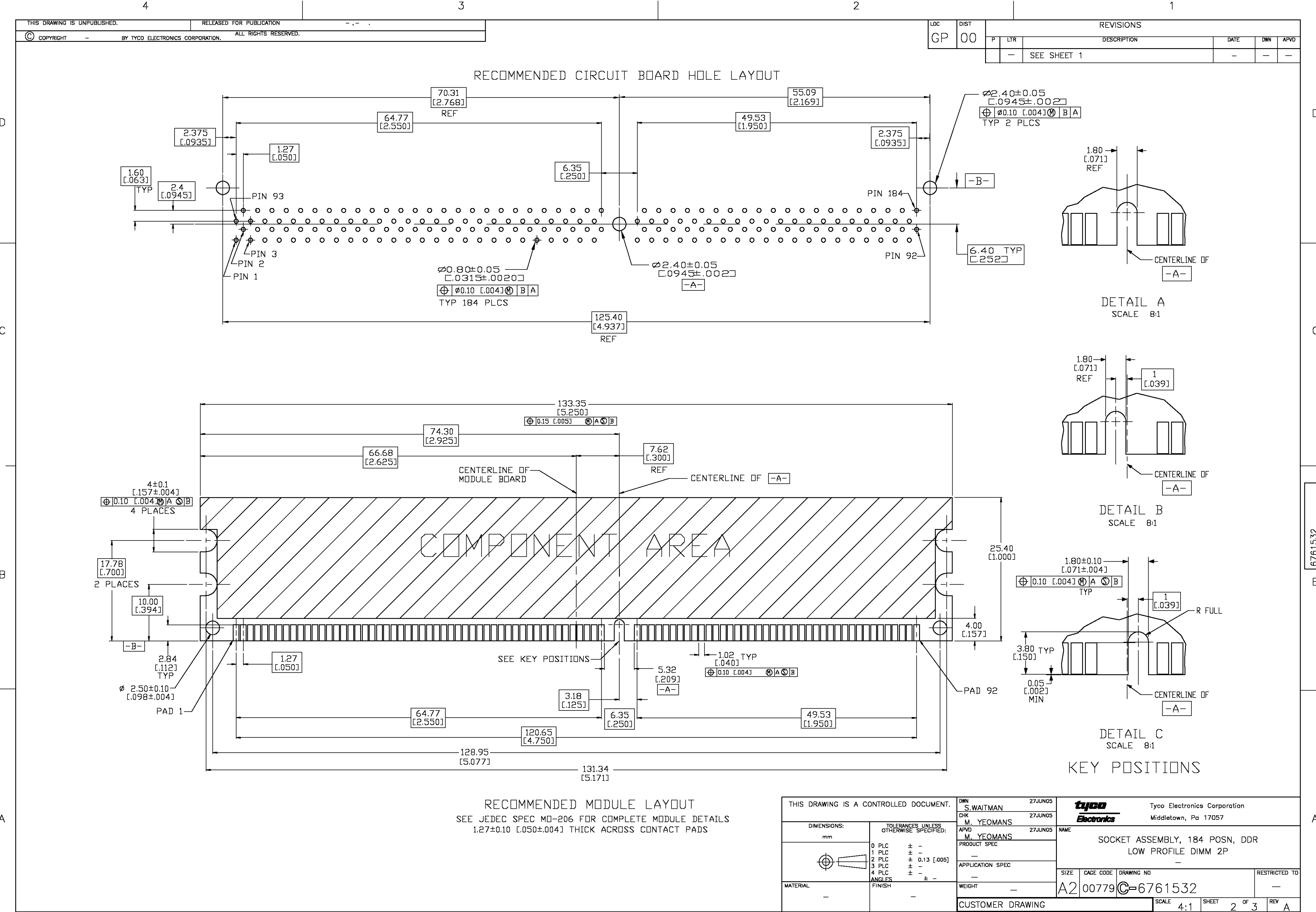
SOCKET ASSEMBLY, 184 POSN, DDR
LOW PROFILE DIMM 2P

SIZE A2
CAGE CODE 00779
DRAWING NO C=6761532

RESTRICTED TO

-

AMP 1471-9 REV 31MAR2000



RECOMMENDED MODULE LAYOUT
SEE JEDEC SPEC MO-206 FOR COMPLETE MODULE DETAILS
1.27±0.10 [0.050±0.04] THICK ACROSS CONTACT PADS

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN S. WAITMAN 27JUN05	tyco Electronics		Tyco Electronics Corporation Middletown, Pa 17057										
DIMENSIONS: mm		CHK M. YEOMANS 27JUN05			NAME SOCKET ASSEMBLY, 184 POSN, DDR LOW PROFILE DIMM 2P										
		TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD M. YEOMANS 27JUN05		SIZE A2		CAGE CODE 00779		DRAWING NO C=6761532		RESTRICTED TO -			
		0 PLC ± - 1 PLC ± - 2 PLC ± 0.13 [0.005] 3 PLC ± - 4 PLC ± - ANGLES ± - FINISH -		PRODUCT SPEC -		APPLICATION SPEC -		WEIGHT -		SCALE 4:1		SHEET 2 OF 3		REV A	
MATERIAL -		FINISH -		CUSTOMER DRAWING											

THIS DRAWING IS UNPUBLISHED.

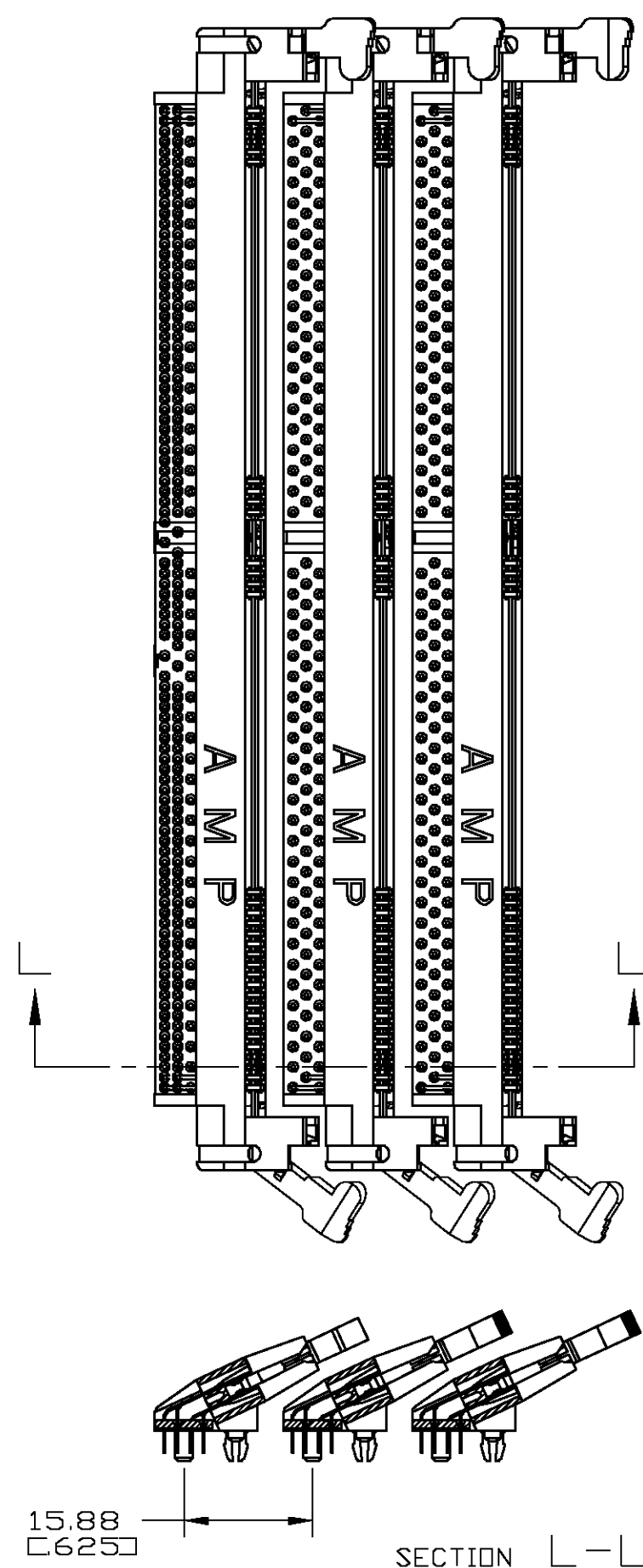
RELEASED FOR PUBLICATION

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LOC
GPDIST
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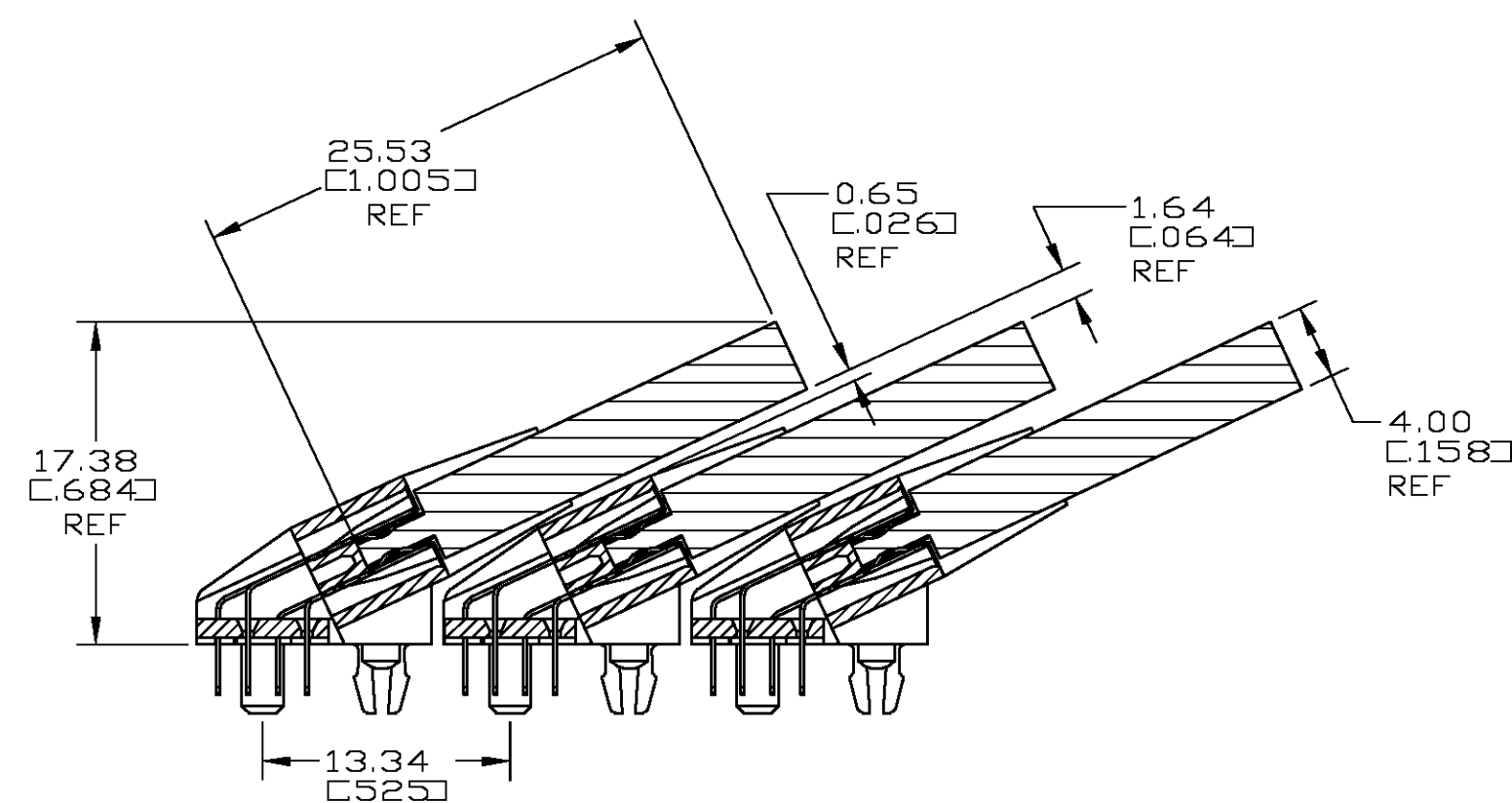
REVISIONS

P	LTR	DESCRIPTION	DATE	DWN	APVD
—	—	SEE SHEET 1	—	—	—



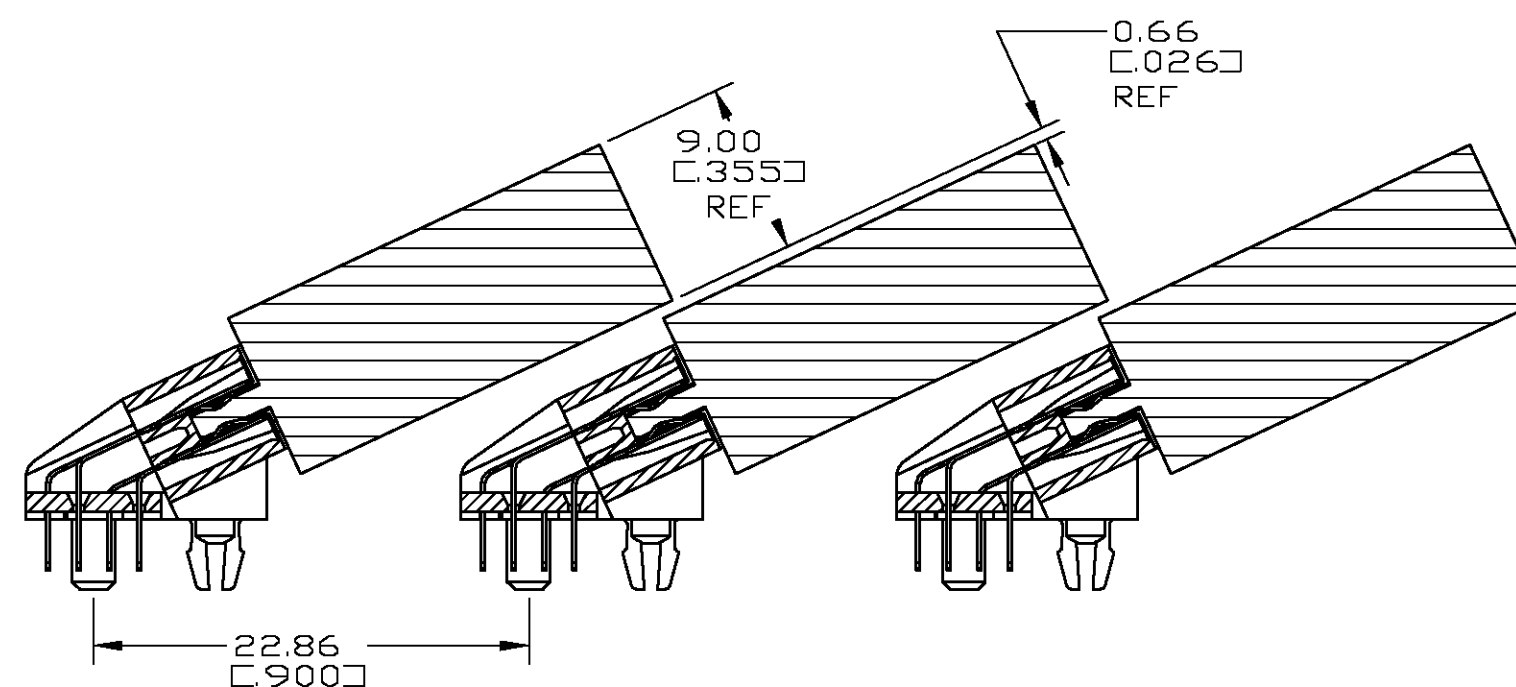
MINIMUM REPAIRABLE SOCKET TO SOCKET SPACING

WITH THE MODULES REMOVED, SOCKETS ON 15.88 [0.625]
OR GREATER SPACING CAN BE INDIVIDUALLY UNSOLDERED
FROM THE BOARD AND REMOVED IF NECESSARY.



MINIMUM SOCKET TO SOCKET SPACING

WITH A 4.00 [0.158] WIDE MODULE BOARD, A SOCKET TO SOCKET SPACING OF 13.34 [0.525] WILL
LEAVE APPROXIMATELY 0.65 [0.026] OF CLEARANCE BETWEEN THE MODULE AND THE NEXT SOCKET BODY.
THIS SPACING MAY OR MAY NOT BE SUITABLE DEPENDING ON YOUR MINIMUM GAP REQUIREMENTS.



POSSIBLE SOCKET TO SOCKET SPACING FOR 9MM MODULE

WITH A 9.00 [0.355] WIDE MODULE BOARD, A SOCKET TO SOCKET SPACING OF 22.86 [0.900] WILL
LEAVE APPROXIMATELY 0.66 [0.026] CLEARANCE BETWEEN THE ADJACENT MODULES.
THIS SPACING MAY OR MAY NOT BE SUITABLE DEPENDING ON YOUR MINIMUM GAP REQUIREMENTS.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN S. WAITMAN 27JUN05	tyco Electronics Tyco Electronics Corporation Middletown, Pa 17057	
DIMENSIONS: mm		CHK M. YEOMANS 27JUN05		
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD M. YEOMANS 27JUN05	NAME SOCKET ASSEMBLY, 184 POSN, DDR LOW PROFILE DIMM 2P	
0 PLC ± — 1 PLC ± — 2 PLC ± 0.13 [0.005] 3 PLC ± — 4 PLC ± — ANGLES ± — FINISH —		PRODUCT SPEC — APPLICATION SPEC — WEIGHT —	SIZE A2	CAGE CODE 00779
MATERIAL —		CUSTOMER DRAWING	DRAWING NO C=6761532	RESTRICTED TO —
		SCALE 4:1	SHEET 3 OF 3	REV A

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